

## APPROVAL SHEET

# WQCW4532 SMD Wire Wound Ceramic Chip Inductors AEC-Q200







\*Contents in this sheet are subject to change without prior notice.



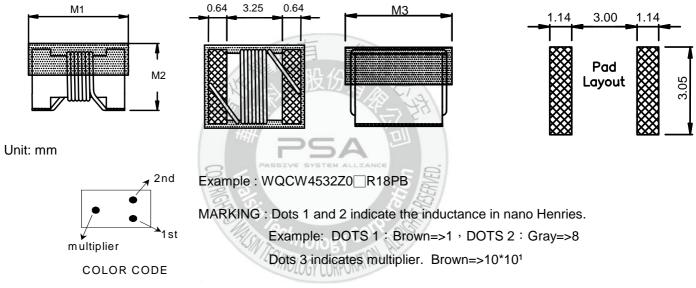
#### **Features**

- 1. Standard chip size bobbin with wire wound coil provides high reliability, productivity and performance.
- 2. Excellence Q and SRF characteristics for RF application, such as LO tank, antenna matching and filter.
- 3. Wide range inductance and various tolerance options.
- 4. RoHS compliant.
- 5. AEC-Q200

#### **Applications**

- 1. Communication: GSM/3G/LTE, Wi-Fi, GPS.
- 2. Consumer: Cabel/Terrestrial/BS Tuner, Bluetooth, Wireless Audio, Remote control.
- 3. M2M: ZigBee, Proprietary wilreless.
- 4. Automotive

#### **Shape and Dimension**



WQCW Series	M1	M2	М3		
4532	4.55±0.40	3.23±0.20	3.61±0.20		

#### **Ordering Information**

WQ	CW	4532	Z0	G	R18	Р	В
Product Code	Series	Dimensions	Series extension	Tolerance	Value	Packing Code	
WQ: Inductor AEC-Q200	SMD Wire Wound Ceramic Chip inductor.	4532 :EIA 1812	Z0:STD	G: ± 2%	82N = 82nH R18 =180nH 1R2 =1200nH	P=7" Reeled (Embossed tape)	B:STD



#### **Electrical Characteristics**

Walsin Part Number	L (nH)	Toleran	Q @50MHz	SRF MHz	DCR mOHM Irms			Color Code	•
Traion I art Rambo	@50MHz	ce	Typical	Min.	Max.	(mA)	1st	2nd	multiplie r
WQCW4532Z0 82NPB	82	G	70	800	60	1500	Gray	Red	Black
WQCW4532Z0 R10PB	100	G	70	850	110	1150	Brown	Black	Brown
WQCW4532Z0 R12PB	120	G	70	800	110	1150	Brown	Red	Brown
WQCW4532Z0 R15PB	150	G	75	860	110	1150	Brown	Green	Brown
WQCW4532Z0□R18PB	180	G	80	850	110	1150	Brown	Gray	Brown
WQCW4532Z0 R22PB	220	G	80	700	105	940	Red	Red	Brown
WQCW4532Z0 R27PB	270	G	85	730	120	940	Red	Violet	Brown
WQCW4532Z0□R33PB	330	G	80	600	135	850	Orange	Orange	Brown
WQCW4532Z0 R39PB	390	G	80	600	140	850	Orange	White	Brown
WQCW4532Z0_1R2PB	1200	G	62	230	1200	480	Brown	Red	Red

- TOLERANCE: G = ±2%
- L AND Q MEASURED AN AGILENT 4291B IMPEDANCE ANALYZER WITH AN AGILENT/HP16193A TEST FIXTURE.
- SRF MEASURED USING AN AGILENT/HP 5071C NETWORK ANALYZER AND A PDC TEST FIXTURE.
- O DCR MESASURED USING A MICRO-OHMMETER.
- O CURRENT THAT CAUSES A 15℃ TEMPERATURE RISE FROM 25℃ AMBIENT.
- ELECTRICAL SPECIFICATIONS AT 25℃.
- **⊙** OPERATING TEMPERATURE :  $-40^{\circ}$  ~  $+150^{\circ}$ .
- STORAGE TEMPERATURE COMPONENT: -40°C to +100°C. TAPE AND REEL PACKAGIN G: -40°C to +80°C.
- MEAN TIME BETWEEN FAILURES (MTBF) 1 BILLION HOURS
- MOISTURE SENSITIVITY LEVEL (MSL) 1 (UNLIMITED FLOOR LIFE AT < 30℃ / 85% RELATIVE HUMIDITY).
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- GRAPHIC IS ONLY FOR DIMENSIONALLY APPLICATION.





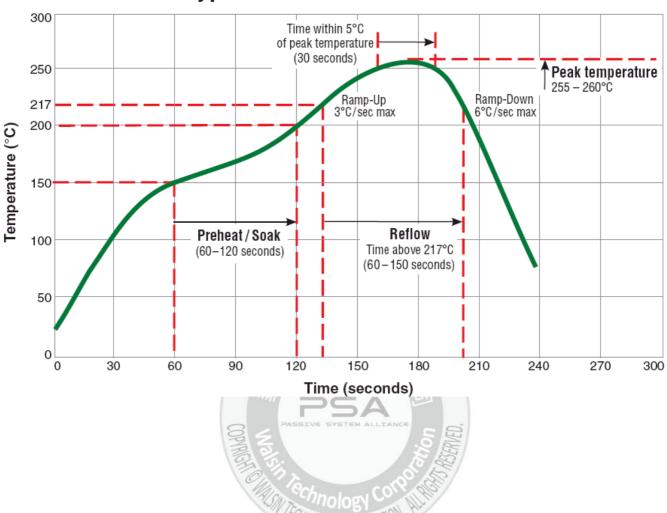
#### **RELIABILITY PERFORMANCE**

Test Item	Test Condition	Standard Source	
High Temperature Exposure (Storage)	1000 hours. at rated operating temperature (e.g. 125℃ part can be stored for 1000 hrs. @ 125℃. Same applies for 105℃ and 85℃. Unpowered.  Measurement at 24±4 hours after test conclusion.	MIL-STD-202 Method 108	
Temperature Cycling	1000 cycles (-40℃ to +125℃). Note: If 85℃ part o r 105℃ part the 1000 cycles will be at that temperature. Measurement at 24±4 hours after test conclusion. 30min maximum dwell time at each temperature extreme. 1 min. maximum transition time.	JESD22 Method JA-104	
Biased Humidity	1000 hours 85℃/85%RH. Unpowered.  Measurement at 24±4 hours after test conclusion.	MIL-STD-202 Method 103	
Operational Life	1000 hours. 105℃. If 85℃ or 125℃ part will be te sted at that temperature.  Measurement at 24±4 hours after test conclusion.	MIL-PRF-27	
Mechanical Shock	Method 213. Condition C, Peak Value: 100g's, Duration: 6ms, Waveform: Half-sine Velocity Change: 12.3ft/sec	MIL-STD-202 Method 213	
Vibration	5g's for 20 minutes, 12 cycles each of 3 orientations.  Note: Use 8"X5" PCB, .031" thick, 7 secure points on one long side and 2 secure points at corners of opposite sides.  Parts mounted within 2" from any secure point. Test from 10-2000 Hz.	MIL-STD-202 Method 204	
Resistance to Soldering Heat	Condition B No pre-heat of samples. Note: Single Wave Solder - Procedure 2 for SMD and Procedure 1 for Leaded with solder within 1.5mm of device body.	MIL-STD-202 Method 210	
ESD	Passive Component Human Body Model (HBM) Electrostatic Discharge (ESD) Test. Only direct contact discharge, record the voltage value what the sample can pass.	AEC-Q200-002 Or ISO/DIS10605	
Solderability	For both Leaded & SMD. Electrical Test not required. Magnification 50X. Conditions: Leaded: Method A @ 235°C, category 3. SMD: a) Method B, 4 hrs @ 155°C dry heat @ 235°C b) Method B @ 215°C category 3. c) Method D category 3 @ 260°C.	J-STD-002	
Flammability	V-0 or V-1 Acceptable	UL-94	
Board Flex	60 sec minimum holding time.	AEC-Q200-005	
Terminal Strength (SMD)	Force of 1.8Kg for 60 seconds.	AEC-Q200-006	



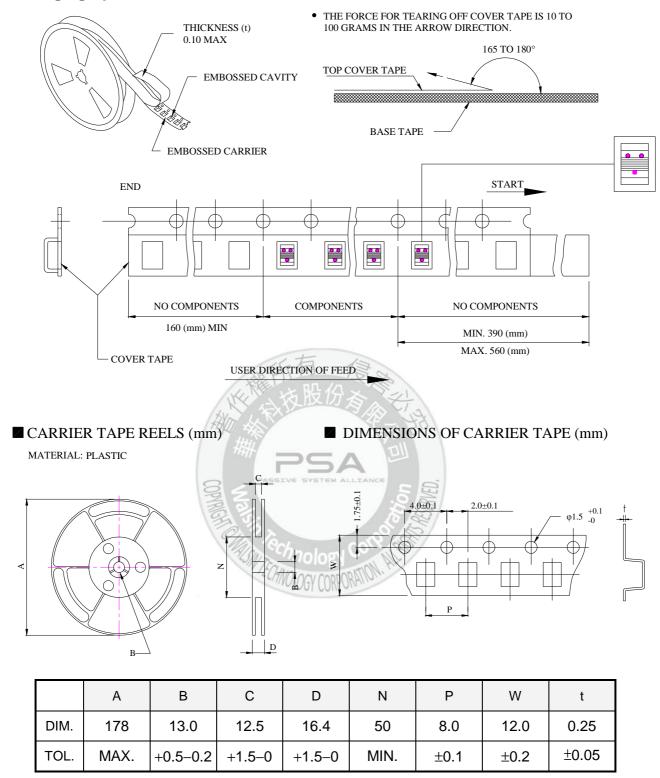
#### **Typical RoHS Reflow Profile**

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#### **Packaging Specification**



Quantity per reel: 0.6K pcs